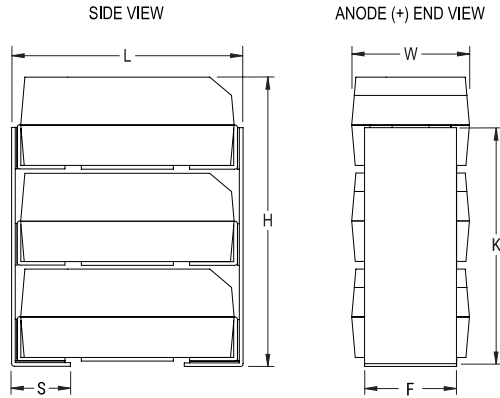



TSP, Tantalum, Polymer Tantalum, HRA, 3,000 uF, 20%, 4 VDC, 3X



Dimensions	
Case Code	3X
L	8mm +/-0.38mm
W	4.4mm +/-0.2mm
H	13.3mm +/-0.38mm
S	1.9mm +/-0.38mm
F	3mm +/-0.2mm
K	11mm +/-0.38mm

Packaging Specifications	
Packaging:	Tray
Packaging Quantity:	50

General Information	
Series:	TSP
Dielectric:	Polymer Tantalum
Style:	Stacked Chip
Description:	SMD, Polymer, KO, Stacks, High Reliability
Features:	High Reliability
RoHS:	No
Prop 65:	 <b>WARNING:</b> Cancer and reproductive harm - <a href="http://www.p65warnings.ca.gov">www.p65warnings.ca.gov</a>
SCIP Number:	30e82d35-b509-48ec-8c77-2d5ec01b3abc
Termination:	Solder Coated
Termination (Stack):	Silver Plated
AEC-Q200:	No
MSL:	3

Specifications	
Capacitance:	3,000 uF
Capacitance Tolerance:	20%
Voltage DC:	4 VDC (105C), 2.68 VDC (125C)
Temperature Range:	-55/+125°C
Rated Temperature:	105°C
Dissipation Factor:	10% 120Hz 25C
Failure Rate:	N/A
Resistance:	3 mOhms (100kHz 25C)
Leakage Current:	1200 uA (5min 25°C)
Testing and Reliability:	4 Cycles At +25C +/-5C

单击下面可查看定价，库存，交付和生命周期等信息

[>>KEMET\(基美\)](#)